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About This Document

Purpose

This document describes how to port and burn the U-boot (that is, bootloader of the Hi3531/Hi3532 board) on the Hi3531/Hi3532 board, and how to using ARM debugging tools.

Related Version

The following table lists the product version related to this document.

Product Name	Version
Hi3531	V100
Hi3532	V100

Intended Audience

This document is intended for:

- Technical support personnel
- Software development engineers

Change History

Updates between document issues are cumulative. Therefore, the latest document issue contains all updates made in previous issues.

Issue 00B10 (2012-02-15)

This issue is the baseline release, which incorporates the following changes:

Chapter 2 Porting the U-boot

In section 2.3, **make** commands are updated.

Issue 00B04 (2012-02-15)

This issue is the third draft release, which incorporates the following changes:

Chapter 3 Burning the U-boot

The description of using the simulator is deleted, and the method of burning the U-boot by using the BOOTROM is added.

Issue 00B03 (2012-01-15)

This issue is the third draft release, which incorporates the following changes:

Chapter 2 Porting the U-boot

In section 2.3, the descriptions of toolchains are added.

Issue 00B02 (2011-11-10)

This issue is the second draft release, which incorporates the following changes:

The information about the H3532 is added.

Issue 00B01 (2011-09-30)

This issue is the first draft release.

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